## SB2D, SB2G, SB2J, SB2K, SB2M

Vishay General Semiconductor

HALOGEN

FREE

## **Surface-Mount Glass Passivated Rectifier**



SMB (DO-214AA)



### **ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	2.0 A					
$V_{RRM}$	200 V, 400 V, 600 V, 800 V, 1000 V					
I <sub>FSM</sub>	55 A					
I <sub>R</sub>	1.0 μΑ					
$V_F$ at $I_F = 2.0 \text{ A}$	0.86 V					
T <sub>J</sub> max.	150 °C					
Package	SMB (DO-214AA)					
Circuit configuration	Single					

#### **FEATURES**

- Low profile package
- · Ideal for automated placement
- · Glass passivated chip junction
- · Low forward voltage drop
- · Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer and telecommunication.

#### **MECHANICAL DATA**

Case: SMB (DO-214AA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

**Terminals:** natte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test **Polarity:** color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SB2D	SB2G	SB2J	SB2K	SB2M	UNIT
Device marking code		B2D	B2G	B2J	B2K	B2M	
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	V
Maximum DC forward current (fig. 1)	I <sub>F</sub> <sup>(1)</sup>	2.0			Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	55			А		
Operating and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150			°C		

#### Note

<sup>(1)</sup> Mounted on 8 mm x 8 mm pad areas, 1 oz. FR4 PCB

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CON	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.90	-	V	
	I <sub>F</sub> = 2.0 A	1 <sub>A</sub> = 25 C		0.96	1.15		
	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 125 °C		0.78	-		
	I <sub>F</sub> = 2.0 A			0.86	1.05		
Reverse current	Detect V	T <sub>A</sub> = 25 °C	- I <sub>R</sub> <sup>(2)</sup>	0.15	1.0	μΑ	
	Rated V <sub>R</sub>	T <sub>A</sub> = 125 °C		36	125		
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1$ $I_{rr} = 0.25 \text{ A}$	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$		2.0		μs	
Typical junction capacitance	Rated V <sub>R</sub> = 4.0	Rated V <sub>R</sub> = 4.0 V, 1 MHz		16		pF	

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1  $\,\%$  duty cycle

(2) Pulse test: Pulse width, ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL SB2D SB2G SB2J SB2K SB2M UNIT						
Typical thermal resistance	R <sub>0</sub> JA (1)			70			°C/W
Typical thermal resistance	R <sub>eJM</sub> (1)			10			C/VV

#### Note

(1) Units mounted on PCB with 8.0 mm x 8.0 mm copper pad areas, 1 oz. FR4 PCB;  $R_{\theta JA}$  - junction-to-ambient  $R_{\theta JM}$  - junction-to-mount

ORDERING INFORMATION (Example)							
PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE BASE QUANTITY DELIVERY MODE							
SB2J-M3/52T	0.096	52T	750	7" diameter plastic tape and reel			
SB2J-M3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel			

## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25 \, ^{\circ}\text{C}$ unless otherwise noted)

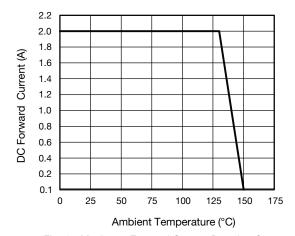


Fig. 1 - Maximum Forward Current Derating Curve

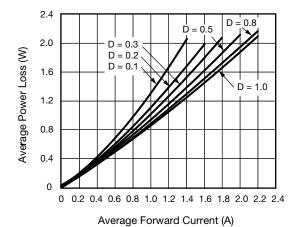


Fig. 2 - Forward Power Loss Characteristics

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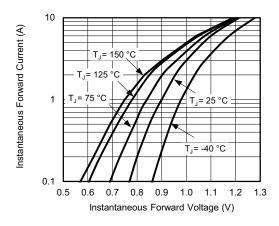


Fig. 3 - Typical Instantaneous Forward Characteristics

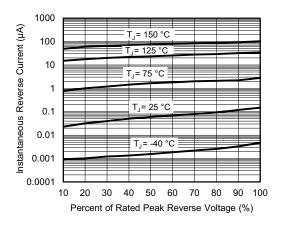


Fig. 4 - Typical Reverse Characteristics

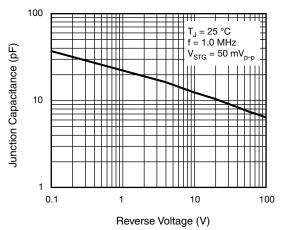


Fig. 5 - Typical Junction Capacitance

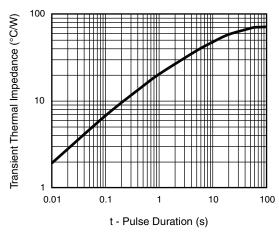
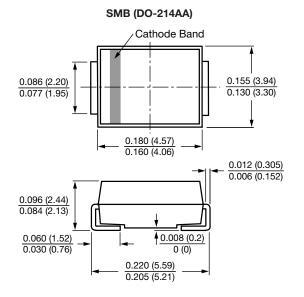
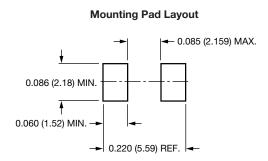


Fig. 6 - Typical Transient Thermal Impedance

#### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)







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